**Participation and Submission Application**   **ASEMD2023**

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| Title of Manuscript |  | | | | | | |
|  | First Name + Last Name | | Organization | | | Order | Research Areas |
| Author Information |  | |  | | |  |  |
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| Address of Contact Author | |  | | | | | |
| Email of corresponding author | |  | | | | | |
| Mobile of corresponding author | |  | | | | | |
| Abstract |  | | | | | | |
| Topics (Multichoice) | 🞏 Large Scale Applied Superconductivity;  🞏 Superconducting Electronics;  🞏 Superconducting and Electromagnetic Materials;  🞏 Electromagnetic Devices;  🞏 Electric Power Devices;  🞏 Electrical Machines; | | | | 🞏 High Efficiency Power Devices;  🞏 Electronic Devices and Circuits;  🞏 Control and Measurement;  🞏 Computation and Informatics;  🞏 Quantum computing, Tera-hertz;  🞏 Others： | | |
| Willing to participate ASEMD2023 submission review? | | | | Yes/No | | | |
| Comment |  | | | | | | |

# Please email back to asemdinquiry@163.com